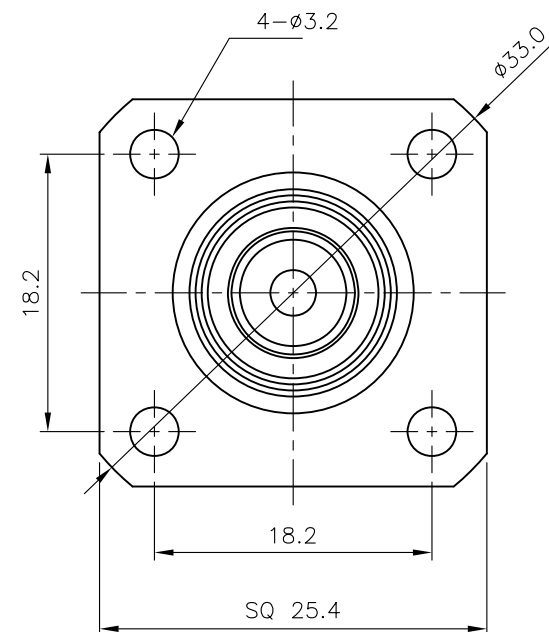
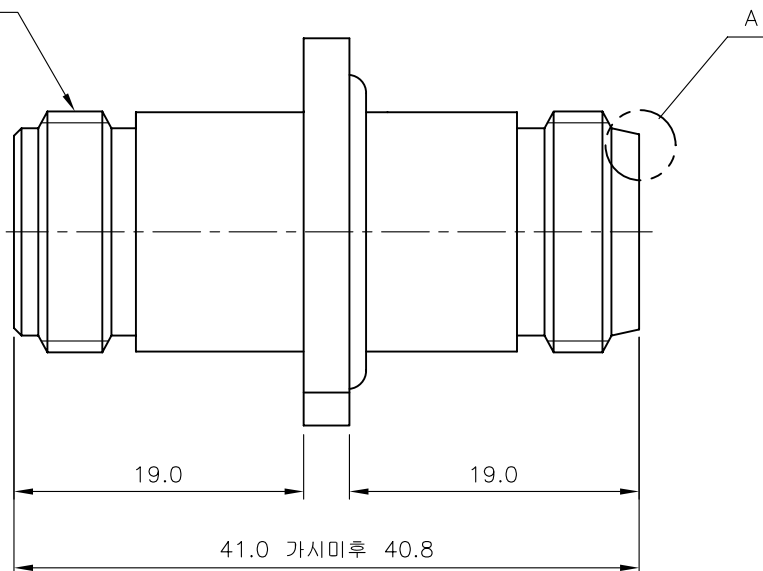


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.M.LEE	I.C.KIM	2014.12.18.
↑	[설번 No.201501-0008] 핀 높이 조정	S.M.LEE	I.C.KIM	2015.01.19.

2-5/8-24UNEF-2A



* 주 기

1. A부분 가시미 작업할것.

5	GASKET	1	SILICONE		DGK00046-N/1
4	INSULATOR	2	TEFLON		DIN00699-N/1
3	CONTACT	1	BeCu	Gold Plate	DCT03326-5/2 DCT03326-5/1
2	BODY	1	MBsBD	Nickel Plate	DBD03818-5/1 DBD00923-5/1
1	BODY	1	MBsBD	Nickel Plate	DBD03808-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	±0.1	2015. 01. 19.				
	Angle	APPROVED BY	I.C.KIM			
MATERIAL	±1°	CHECKED BY	TITLE N50 (J) N50 (J) 4 HOLE			
-		DRAWN BY	S.M.LEE			
FINISH	-	SCALE	UNIT	 A4		
		2/1	mm			
				DWG NO. AD00543-7/1		
				REVISION	I R	SHEET 1 of 1